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FDS6912A

Dual N-Channel Logic Level PowerTrench^o MOSFET

General Description

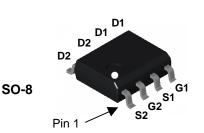
These N-Channel Logic Level MOSFETs are produced using ON Semiconductor's advanced PowerTrench process that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

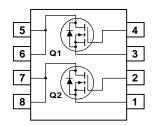
These devices are well suited for low voltage and battery powered applications where low in-line power loss and fast switching are required.

Features

• 6 A, 30 V. $\begin{array}{l} {\sf R}_{{\sf DS}({\sf ON})} = 28 \mbox{ m}\Omega \ @ \ {\sf V}_{{\sf GS}} = 10 \mbox{ V} \\ {\sf R}_{{\sf DS}({\sf ON})} = 35 \mbox{ m}\Omega \ @ \ {\sf V}_{{\sf GS}} = 4.5 \mbox{ V} \end{array}$

- · Fast switching speed
- Low gate charge
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- High power and current handling capability





Absolute Maximum Ratings T_A=25°C unless otherwise noted

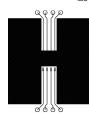
Symbol		Parameter		Ratings	Units	
V _{DSS}	Drain-Source	urce Voltage		30	V	
V _{GSS}	Gate-Sourc	e Voltage		± 20	V	
I _D	Drain Current – Continuous		(Note 1a)	6	А	
	– Pulsed			20		
P _D	Power Diss	ipation for Single Operat	ion (Note 1a)	1.6	W	
			(Note 1b)	1.0		
			(Note 1c)	0.9		
T _J , T _{STG}	Operating and Storage Junction Temperature Range			–55 to +150 °		
Therma	l Charac	teristics				
$R_{ ext{ hetaJA}}$	Thermal Re	sistance, Junction-to-An	ction-to-Ambient (Note 1a) 78		°C/W	
R _{θJC}	Thermal Resistance, Junction-to-Case		ASE (Note 1)	40	°C/W	
Packag	e Markin	g and Ordering	Information			
Device Marking		Device	Reel Size	Tape width	Quantity	
	912A	FDS6912A	13"	12mm	2500 units	

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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics					
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$, $I_D = 250 \mu A$	30			V
ΔBV _{DSS} ΔBV _{DSS} ΔTJ	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, Referenced to 25°C	00	25		mV/°C
DSS	Zero Gate Voltage Drain Current	$V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55^{\circ}\text{C}$			1 10	μA
I _{GSS}	Gate-Source Leakage	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
On Char	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1	1.9	3	V
$\Delta V_{GS(th)}$ ΔT_{J}	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, Referenced to 25° C		-4.5		mV/°0
R _{DS(on)}	Static Drain–Source On–Resistance			19 24 27	28 35 44	mΩ
D(on)	On-State Drain Current	$V_{GS} = 10 \text{ V}, V_{DS} = 5 \text{ V}$	20			Α
g FS	Forward Transconductance	$V_{DS} = 10 \text{ V}, I_D = 6 \text{ A}$		25		S
Dynamio	c Characteristics					
C _{iss}	Input Capacitance	$V_{DS} = 15 V$, $V_{GS} = 0 V$,		575		pF
Coss	Output Capacitance	f = 1.0 MHz		145		pF
C _{rss}	Reverse Transfer Capacitance			65		pF
R _G	Gate Resistance	$V_{GS} = 15 \text{ mV}, \text{ f} = 1.0 \text{ MHz}$		2.1		Ω
Switchir	ng Characteristics (Note 2)					
t _{d(on)}	Turn–On Delay Time	$V_{DD} = 15 V$, $I_D = 1 A$,		8	16	ns
t _r	Turn–On Rise Time	$V_{GS} = 10 \text{ V}, R_{GEN} = 6 \Omega$		5	10	ns
t _{d(off)}	Turn–Off Delay Time			23	37	ns
t _f	Turn–Off Fall Time			3	6	ns
Qg	Total Gate Charge	$V_{DS} = 15 V$, $I_{D} = 6 A$,		5.8	8.1	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = 5 V$		1.7		nC
Q _{gd}	Gate-Drain Charge			2.1		nC
Drain–S	ource Diode Characteristics	and Maximum Ratings				
ls	Maximum Continuous Drain-Source				1.3	Α
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$, $I_S = 1.3 A$ (Note 2)		0.75	1.2	V
t _{rr}	Diode Reverse Recovery Time	$I_F = 6 A, \qquad d_{iF}/d_t = 100 A/\mu s$		20		nS
Q _{rr}	Diode Reverse Recovery Charge	7		10	1	nC

Notes:

1. R_{0,JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{θ JC} is guaranteed by design while R_{θ CA} is determined by the user's board design.



a) 78°C/W when mounted on a 0.5in² pad of 2 oz copper



b) 125°C/W when mounted on a 0.02 in² pad of 2 oz copper

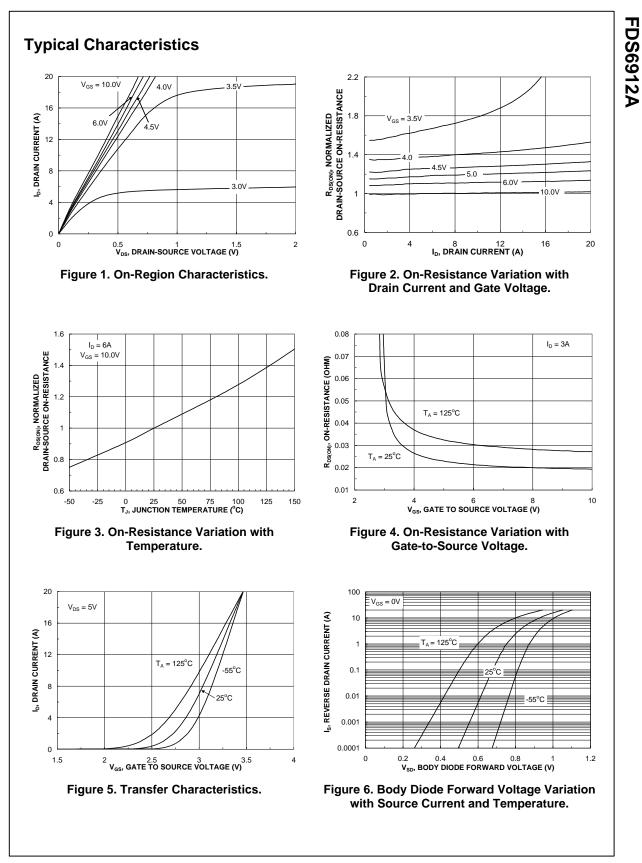
c) 135°C/W when mounted on a minimum mounting pad.

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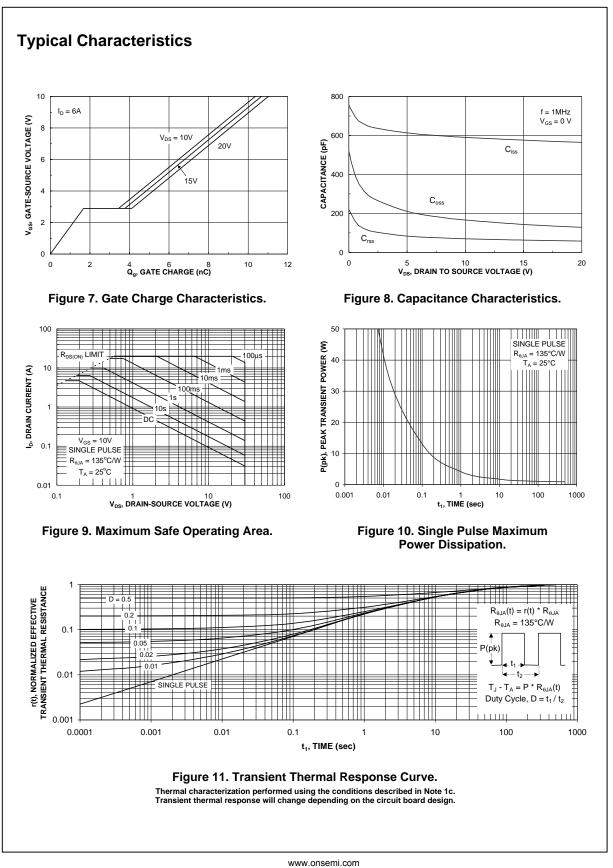
Scale 1 : 1 on letter size paper

Pulse Test: Pulse Width < 300µs, Duty Cycle < 2.0%

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